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IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF :
TOSHIAKI SHINOHARA : EXAMINER: NGUYEN, D. P.
SERIAL NO: 09/895,319 :
FILED: JULY 2, 2001 : GROUP ART UNIT: 2814
FOR: SEMICONDUCTOR DEVICE AND:
METHOD OF MANUFACTURING
SAME

AMENDMENT

ASSISTANT COMMISSIONER FOR PATENTS
WASHINGTON, D.C. 20231

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JUL 10 2002
TECHNOLOGY CENTER 2800

SIR:

This communication is in response to the Office Action dated April 10, 2002.

IN THE CLAIMS

Please cancel Claims 9-11 without prejudice.

The following is a clean copy of Claims 1, 3 and 5-8, with a marked-up copy
attached.

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1. (Amended) A semiconductor device comprising:
- a semiconductor element;
 - a lead frame having a first surface on which said semiconductor element is mounted,
 - and a second surface opposite to said first surface;
 - a metal block on said second surface of said lead frame;
 - an insulation layer on said metal block opposite said lead frame; and